

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT7962058

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
KUEN CHEE EE	05/25/2022
LONG ZHANG	05/25/2022
DAVID GLAESS	05/26/2022
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	MAGNECOMP CORPORATION
<b>Street Address:</b>	29970 TECHNOLOGY DRIVE
<b>Internal Address:</b>	SUITE 216C
<b>City:</b>	MURRIETA
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	92563
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	18111402
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(650)833-2001
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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<b>ATTORNEY DOCKET NUMBER:</b>	427767-429000
<b>NAME OF SUBMITTER:</b>	MARIA S. SWIATEK
<b>SIGNATURE:</b>	/Maria S. Swiatek/
<b>DATE SIGNED:</b>	05/18/2023
<b>Total Attachments: 5</b>	
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ASSIGNMENT

WHEREAS, we, Kuen Chee Ee, residing in Chino, CA; Long Zhang, residing in Winchester, CA; and David Glaess, residing in Bangkok, Thailand have invented a "*Mount Plate With Suspension Circuit Indentations*" for which we have executed application papers for a U.S. patent thereon, which was filed on February 22, 2022, serial no. 63/312,708; and

WHEREAS, Magnecomp Corporation, a California Corporation, having a place of business located at 29970 Technology Drive, Suite 216C, Murrieta, CA 92563 is desirous of acquiring the exclusive right, title and interest in and to said inventions and in the Letters Patent to be granted and issued therefor in the United States of America and its territories and possessions, and all countries foreign thereto;

NOW, THEREFORE, for a valuable consideration, the receipt of which is hereby acknowledged, we, Kuen Chee Ee, Long Zhang and David Glaess (collectively the "Inventors"), do hereby sell, assign, transfer and set over unto said Magnecomp Corporation, its successors and assigns, the full and exclusive right, title and interest: (a) in and to said application and said inventions and any priority applications thereto, and any later filed United States utility or foreign applications claiming priority to said application; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a priority application, utility, division, substitution, continuation or continuation-in-part of any of said applications; and (d) in and to each and every reissue or extension of any of said patents; and (e) all claims for damages by reason of past infringement of said patents together with any back damages and royalties accrued; and we hereby authorize and request the Commissioner of

Patents and Trademarks to issue said Letters Patent to said Magnecomp Corporation, its successors and assigns, in accordance with this Assignment.

The Inventors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and foreign countries for perfecting in said Assignee the right, title and interest herein conveyed; for prosecuting any of said applications; and for filing and prosecuting utility, substitute, divisional, continuing or additional applications covering said invention.

The Inventors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

40,270

Attorney Docket No.: 427767-429099

[ASSIGNMENT CONTINUATION]

Re: U.S. Patent Application entitled: *Mount Plate With Suspension Circuit Indentations*  
Inventor: Kuen Chee Ee

IN WITNESS WHEREOF, the said Inventor has executed and delivered this instrument  
to said Assignee this 25 day of May, 2022.

  
\_\_\_\_\_  
Kuen Chee Ee

Witnessed by: SIEW FERN KHR  
Name: SIEW FERN KHR  
Date: 5/25/2022

[ASSIGNMENT CONTINUATION]

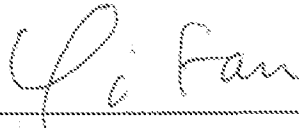
Re: U.S. Patent Application entitled: *Mount Plate With Suspension Circuit Indentations*  
Inventor: Long Zhang

IN WITNESS WHEREOF, the said Inventor has executed and delivered this instrument  
to said Assignee this 25<sup>th</sup> day of May, 2022.



Long Zhang

Witnessed by:



Name: Yi Fan

Date: 05/25/2022

40,270

Attorney Docket No.: 427767-429099

[ASSIGNMENT CONTINUATION]

Re: U.S. Patent Application entitled: *Mount Plate With Suspension Circuit Indentations*  
Inventor: David Glaess

IN WITNESS WHEREOF, the said Inventor has executed and delivered this instrument  
to said Assignee this 26 day of May, 2022.

David Glaess  
David Glaess

Witnessed by: Preecha S.

Name: Preecha Sudachun

Date: 26-May-2022